74LVC4245A-Q100

Octal dual supply translating transceiver; 3-state

Rev. 4 — 1 September 2023

Product data sheet

1. General description

The 74LVC4245A-Q100 is an octal dual supply translating transceiver featuring 3-state bus compatible outputs in both send and receive directions. It is designed to interface between a 3 V and 5 V bus in a mixed 3 V and 5 V supply environment. The device features an output enable input (\overline{OE}) and a send/receive input (\overline{DIR}) for direction control. A HIGH on \overline{OE} causes the outputs to assume a high-impedence OFF-state, effectively isolating the buses. In suspend mode, when either supply is zero, there is no current path between supplies. $V_{CCA} \ge V_{CCB}$, except in suspend mode. Schmitt-trigger action at all inputs makes the circuit tolerant of slower input rise and fall times

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- 5 V tolerant inputs/outputs, for interfacing with 5 V logic
- Wide supply voltage range:
 - 3 V bus (V_{CC(B)}): 1.5 V to 3.6 V
 - 5 V bus (V_{CC(A)}): 1.5 V to 5.5 V
- CMOS low-power consumption
- TTL interface capability at 3.3 V
- Overvoltage tolerant control inputs to 5.5 V
- High-impedance when V_{CC(A)} = 0 V
- · Complies with JEDEC standard no. JESD8B/JESD36
- Latch-up performance meets requirements of JESD78 Class 1
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Multiple package options
- DHVQFN package with Side-Wettable Flanks enabling Automatic Optical Inspection (AOI) of solder joints

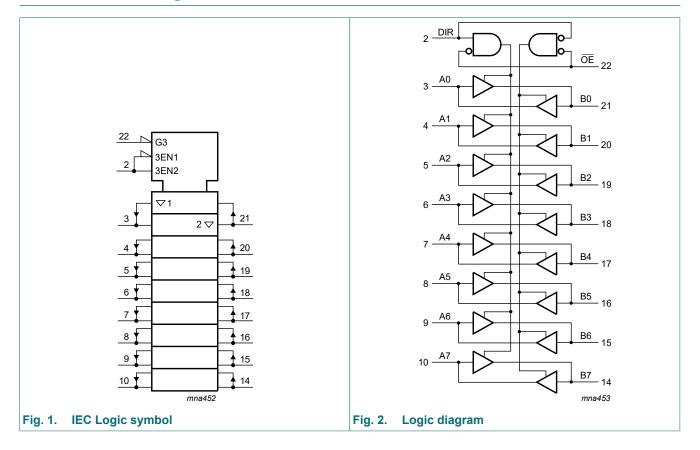
3. Ordering information

Table 1. Ordering information

| Type number | Package | | | | | | | | | |
|-------------------|-------------------|----------|--|----------|--|--|--|--|--|--|
| | Temperature range | Name | Description | Version | | | | | | |
| 74LVC4245APW-Q100 | -40 °C to +125 °C | TSSOP24 | plastic thin shrink small outline package; 24 leads; body width 4.4 mm | SOT355-1 | | | | | | |
| 74LVC4245ABQ-Q100 | -40 °C to +125 °C | DHVQFN24 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body 3.5 × 5.5 × 0.85 mm | SOT815-1 | | | | | | |

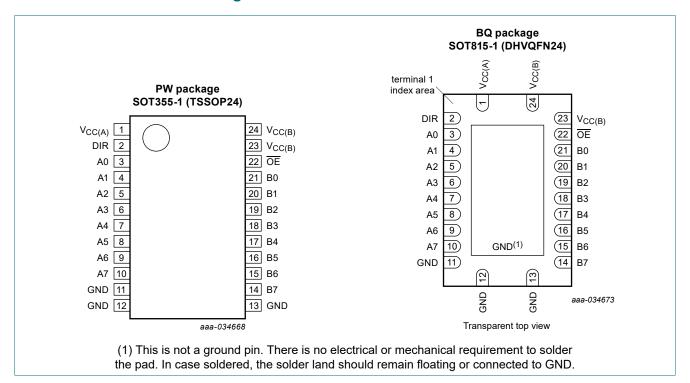


4. Functional diagram



5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

| Table 2. Fill description | | | | | | | | | | |
|--------------------------------|---|--|--|--|--|--|--|--|--|--|
| Pin | Description | | | | | | | | | |
| 1 | supply voltage (5 V bus) | | | | | | | | | |
| 23, 24 | supply voltage (3 V bus) | | | | | | | | | |
| 11, 12, 13 | ground (0 V) | | | | | | | | | |
| 2 | direction control | | | | | | | | | |
| 3, 4, 5, 6, 7, 8, 9, 10 | data input or output | | | | | | | | | |
| 21, 20, 19, 18, 17, 16, 15, 14 | data input or output | | | | | | | | | |
| 22 | output enable input (active LOW) | | | | | | | | | |
| | 1 23, 24 11, 12, 13 2 3, 4, 5, 6, 7, 8, 9, 10 21, 20, 19, 18, 17, 16, 15, 14 | | | | | | | | | |

6. Functional description

Table 3. Functional table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

| Input | | Input/output | | | | |
|-------|-----|--------------|-------|--|--|--|
| OE | DIR | An | Bn | | | |
| L | L | A = B | input | | | |
| L | Н | input | B = A | | | |
| Н | X | Z | Z | | | |

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|--------------------|-------------------------|---|-----|------|-----------------------|------|
| V _{CC(A)} | supply voltage A | | | -0.5 | +6.5 | V |
| V _{CC(B)} | supply voltage B | | | -0.5 | +4.6 | V |
| I _{IK} | input clamping current | V _I < 0 V | | -50 | - | mA |
| VI | input voltage | | [1] | -0.5 | +6.5 | V |
| I _{OK} | output clamping current | V _O > V _{CCO} or V _O < 0 V | [2] | - | ±50 | mA |
| Vo | output voltage | output HIGH or LOW state | [1] | -0.5 | V _{CC} + 0.5 | V |
| | | output 3-state | [1] | -0.5 | +6.5 | V |
| Io | output current | V _O = 0 V to V _{CCO} | [2] | - | ±50 | mA |
| I _{CC} | supply current | | | - | 100 | mA |
| I _{GND} | ground current | | | -100 | - | mA |
| T _{stg} | storage temperature | | | -65 | +150 | °C |
| P _{tot} | total power dissipation | T_{amb} = -40 °C to +125 °C | [3] | - | 500 | mW |

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

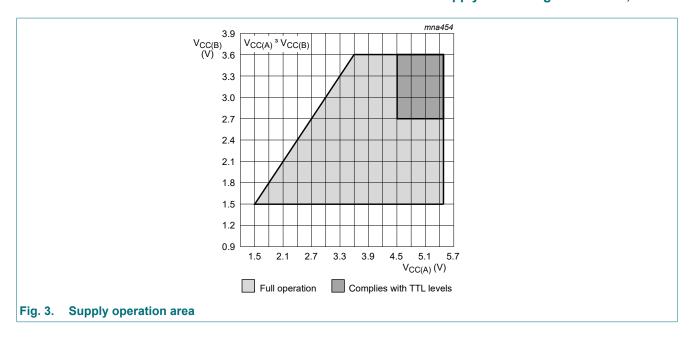
8. Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--------------------|-------------------------------------|--|-----|-----|-----------------|------|
| V _{CC(A)} | supply voltage A | $V_{CC(A)} \ge V_{CC(B)}$; see <u>Fig. 3</u> for maximum speed performance | 1.5 | - | 5.5 | V |
| V _{CC(B)} | supply voltage B | $V_{CC(A)} \ge V_{CC(B)}$; see <u>Fig. 3</u> for low-voltage applications | 1.5 | - | 3.6 | V |
| VI | input voltage | for control inputs | 0 | - | 5.5 | V |
| Vo | output voltage | output HIGH or LOW state | 0 | - | V _{CC} | V |
| | | output 3-state | 0 | - | 5.5 | V |
| T _{amb} | ambient temperature | | -40 | - | +125 | °C |
| Δt/ΔV | input transition rise and fall rate | V _{CC(B)} = 2.7 V to 3.0 V | - | - | 20 | ns/V |
| | | V _{CC(B)} = 3.0 V to 3.6 V | - | - | 10 | ns/V |
| | | V _{CC(A)} = 3.0 V to 4.5 V | - | - | 20 | ns/V |
| | | V _{CC(A)} = 4.5 V to 5.5 V | - | - | 10 | ns/V |

^[2] V_{CCO} is the supply voltage associated with the output.

^[3] For SOT355-1 (TSSOP24) package: P_{tot} derates linearly with 12.4 mW/K above 110 °C. For SOT815-1 (DHVQFN24) package: P_{tot} derates linearly with 15.0 mW/K above 117 °C.



9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ [1] | Max | Unit |
|----------------------|-----------------------------|---|--------------------------|--------------------|------|------|
| T _{amb} = - | 40 °C to +85 °C | | | | | , |
| V _{IH} | HIGH-level input | V _{CC(B)} = 2.7 V to 3.6 V | 2.0 | - | - | V |
| | voltage | V _{CC(A)} = 4.5 V to 5.5 V | 2.0 | - | - | V |
| V _{IL} | LOW-level input | V _{CC(B)} = 2.7 V to 3.6 V | - | - | 8.0 | V |
| | voltage | V _{CC(A)} = 4.5 V to 5.5 V | - | - | 0.8 | V |
| V _{OH} | HIGH-level output | $V_I = V_{IH}$ or V_{IL} | | | | |
| | voltage | $V_{CC(B)} = 2.7 \text{ V to } 3.6 \text{ V; I}_{O} = -100 \mu\text{A}$ | V _{CC(B)} - 0.2 | V _{CC(B)} | - | V |
| | | V _{CC(B)} = 2.7 V; I _O = -12 mA | V _{CC(B)} - 0.5 | - | - | V |
| | | V _{CC(B)} = 3.0 V; I _O = -24 mA | V _{CC(B)} - 0.8 | - | - | V |
| | | $V_{CC(A)}$ = 4.5 V to 5.5 V; I_{O} = -100 μA | V _{CC(A)} - 0.2 | V _{CC(A)} | - | V |
| | | V _{CC(A)} = 4.5 V; I _O = -12 mA | V _{CC(A)} - 0.5 | - | - | V |
| | | V _{CC(A)} = 4.5 V; I _O = -24 mA | V _{CC(A)} - 0.8 | - | - | V |
| V _{OL} | LOW-level output | $V_I = V_{IH}$ or V_{IL} | | | | |
| | voltage | $V_{CC(B)}$ = 2.7 V to 3.6 V; I_{O} = 100 μ A | - | - | 0.20 | V |
| | | V _{CC(B)} = 2.7 V; I _O = 12 mA | - | - | 0.40 | V |
| | | V _{CC(B)} = 3.0 V; I _O = 24 mA | - | - | 0.55 | V |
| | | $V_{CC(A)} = 4.5 \text{ V to } 5.5 \text{ V; I}_{O} = 100 \mu\text{A}$ | - | - | 0.20 | V |
| | | V _{CC(A)} = 4.5 V; I _O = 12 mA | - | - | 0.40 | V |
| | | V _{CC(A)} = 4.5 V; I _O = 24 mA | - | - | 0.55 | V |
| lı | input leakage current | V _I = 5.5 V or GND | - | ±0.1 | ±5 | μA |
| l _{OZ} | OFF-state output | $V_I = V_{IH} \text{ or } V_{IL}$ [2] | | | | |
| | current | $V_{CC(B)} = 3.6 \text{ V}; V_O = V_{CC(B)} \text{ or GND}$ | - | ±0.1 | ±5 | μA |
| | | $V_{\rm CC(A)}$ = 5.5 V; $V_{\rm O}$ = $V_{\rm CC(A)}$ or GND | - | ±0.1 | ±5 | μΑ |
| I _{CC} | supply current | I _O = 0 A | | | | |
| | | $V_{CC(B)}$ = 3.6 V; other inputs at $V_{CC(B)}$ or GND | - | 0.1 | 10 | μA |
| | | $V_{CC(A)} = 5.5 \text{ V};$ other inputs at $V_{CC(A)}$ or GND | - | 0.1 | 10 | μA |
| ΔI _{CC} | additional supply | per pin; I _O = 0 A | | | | |
| | current | $V_{CC(B)}$ = 2.7 V to 3.6 V; V_I = $V_{CC(B)}$ - 0.6 V; other inputs at $V_{CC(B)}$ or GND | - | 5 | 500 | μA |
| | | $V_{CC(A)}$ = 4.5 V to 5.5 V; V_I = $V_{CC(A)}$ - 0.6 V; other inputs at $V_{CC(A)}$ or GND | - | 5 | 500 | μA |
| Cı | input capacitance | | - | 4.0 | - | pF |
| C _{I/O} | input/output capacitance | An and Bn | - | 5.0 | - | pF |

Product data sheet

| Symbol | Parameter | Conditions | Min | Typ [1] | Max | Unit |
|-----------------------|--|---|---------------------------|---------|------|------|
| T _{amb} = -4 | 40 °C to +125 °C | | | ' | | _ |
| V _{IH} | HIGH-level input | V _{CC(B)} = 2.7 V to 3.6 V | 2.0 | - | - | V |
| | voltage | V _{CC(A)} = 4.5 V to 5.5 V | 2.0 | - | - | V |
| V _{IL} | LOW-level input | V _{CC(B)} = 2.7 V to 3.6 V | - | - | 0.8 | V |
| | voltage | V _{CC(A)} = 4.5 V to 5.5 V | - | - | 0.8 | V |
| V _{OH} | HIGH-level output | $V_I = V_{IH}$ or V_{IL} | | | | |
| | voltage | $V_{CC(B)} = 2.7 \text{ V to } 3.6 \text{ V; I}_{O} = -100 \mu\text{A}$ | V _{CC(B)} - 0.3 | - | - | V |
| | | V _{CC(B)} = 2.7 V; I _O = -12 mA | V _{CC(B)} - 0.65 | - | - | V |
| | | V _{CC(B)} = 3.0 V; I _O = -24 mA | V _{CC(B)} - 1.0 | - | - | V |
| | | $V_{CC(A)} = 4.5 \text{ V to } 5.5 \text{ V; } I_O = -100 \mu\text{A}$ | V _{CC(A)} - 0.3 | - | - | V |
| | | V _{CC(A)} = 4.5 V; I _O = -12 mA | V _{CC(A)} - 0.65 | - | - | V |
| | | V _{CC(A)} = 4.5 V; I _O = -24 mA | V _{CC(A)} - 1.0 | - | - | V |
| V _{OL} | LOW-level output | $V_I = V_{IH}$ or V_{IL} | | | | |
| | voltage | $V_{CC(B)}$ = 2.7 V to 3.6 V; I_{O} = 100 μ A | - | - | 0.30 | V |
| | | V _{CC(B)} = 2.7 V; I _O = 12 mA | - | - | 0.60 | V |
| | | V _{CC(B)} = 3.0 V; I _O = 24 mA | - | - | 0.80 | V |
| | | $V_{CC(A)} = 4.5 \text{ V to } 5.5 \text{ V; } I_O = 100 \mu\text{A}$ | - | - | 0.30 | V |
| | | V _{CC(A)} = 4.5 V; I _O = 12 mA | - | - | 0.60 | V |
| | | V _{CC(A)} = 4.5 V; I _O = 24 mA | - | - | 0.80 | V |
| I _I | input leakage current | V _I = 5.5 V or GND | - | - | ±20 | μA |
| l _{OZ} | OFF-state output | $V_I = V_{IH} \text{ or } V_{IL}$ [2] | | | | |
| | current | $V_{CC(B)} = 3.6 \text{ V}; V_O = V_{CC(B)} \text{ or GND}$ | - | - | ±20 | μΑ |
| | | $V_{CC(A)} = 5.5 \text{ V}; V_O = V_{CC(A)} \text{ or GND}$ | - | - | ±20 | μA |
| I _{CC} | supply current | I _O = 0 A | | | | |
| | | $V_{CC(B)} = 3.6 \text{ V};$ other inputs at $V_{CC(B)}$ or GND | - | - | 40 | μA |
| | $V_{CC(A)} = 5.5 \text{ V};$ other inputs at $V_{CC(A)}$ or GND | - | - | 40 | μA | |
| ΔI _{CC} | additional supply | per pin; I _O = 0 A | | | | |
| | current | $V_{CC(B)}$ = 2.7 V to 3.6 V; V_I = $V_{CC(B)}$ - 0.6 V; other inputs at $V_{CC(B)}$ or GND | - | - | 5000 | μA |
| | | $V_{\rm CC(A)}$ = 4.5 V to 5.5 V; $V_{\rm I}$ = $V_{\rm CC(A)}$ - 0.6 V; other inputs at $V_{\rm CC(A)}$ or GND | - | - | 5000 | μA |

All typical values are measured at $V_{CC(A)}$ = 5.0 V, $V_{CC(B)}$ = 3.3 V and T_{amb} = 25 °C. For transceivers, the parameter I_{OZ} includes the input leakage current.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). $V_{CC(A)} = 4.5 \text{ V}$ to 5.5 V; $t_r = t_f \le 2.5 \text{ ns}$. For test circuit see Fig. 6.

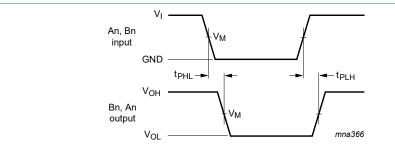
| Symbol | Parameter | Conditions | V _{CC(B)} | -40 | °C to +85 | 5°C | -40 °C to | +125 °C | Unit |
|------------------------|-------------------------------|--|--------------------|-----|-----------|-----|-----------|---------|------|
| | | | | Min | Typ [1] | Max | Min | Max | |
| t _{PHL} | HIGH to LOW | An to Bn; see Fig. 4 | 2.7 V | 1.0 | 3.6 | 6.3 | 1.0 | 8.0 | ns |
| | propagation delay | | 3.0 V to 3.6 V | 1.0 | 3.3 | 6.3 | 1.0 | 8.0 | ns |
| | | Bn to An; see Fig. 4 | 2.7 V | 1.0 | 3.4 | 6.1 | 1.0 | 8.0 | ns |
| | | | 3.0 V to 3.6 V | 1.0 | 3.4 | 6.1 | 1.0 | 8.0 | ns |
| t _{PLH} | LOW to HIGH | An to Bn; see Fig. 4 | 2.7 V | 1.0 | 3.3 | 6.7 | 1.0 | 8.5 | ns |
| | propagation delay | | 3.0 V to 3.6 V | 1.0 | 2.8 | 6.5 | 1.0 | 8.5 | ns |
| | | Bn to An; see Fig. 4 | 2.7 V | 1.0 | 3.0 | 5.0 | 1.0 | 6.5 | ns |
| | | | 3.0 V to 3.6 V | 1.0 | 3.0 | 5.0 | 1.0 | 6.5 | ns |
| t _{PZL} | OFF-state to | OE to An; see Fig. 5 | 2.7 V | 1.0 | 4.5 | 9.0 | 1.0 | 11.5 | ns |
| | LOW propagation delay | | 3.0 V to 3.6 V | 1.0 | 4.5 | 9.0 | 1.0 | 11.5 | ns |
| | delay | OE to Bn; see Fig. 5 | 2.7 V | 1.0 | 4.4 | 8.7 | 1.0 | 11.0 | ns |
| | | | 3.0 V to 3.6 V | 1.0 | 3.8 | 8.1 | 1.0 | 10.5 | ns |
| t _{PZH} | OFF-state to | OE to An; see Fig. 5 | 2.7 V | 1.0 | 4.5 | 8.1 | 1.0 | 10.5 | ns |
| HIGH propagation delay | | 3.0 V to 3.6 V | 1.0 | 4.5 | 8.1 | 1.0 | 10.5 | ns | |
| | delay | OE to Bn; see Fig. 5 | 2.7 V | 1.0 | 4.3 | 8.7 | 1.0 | 11.0 | ns |
| | | 3.0 V to 3.6 V | 1.0 | 3.2 | 8.1 | 1.0 | 10.5 | ns | |
| t _{PLZ} | LOW to | OE to An; see Fig. 5 | 2.7 V | 1.0 | 2.9 | 7.0 | 1.0 | 9.0 | ns |
| | OFF-state propagation delay | | 3.0 V to 3.6 V | 1.0 | 2.9 | 7.0 | 1.0 | 9.0 | ns |
| | propagation delay | OE to Bn; see Fig. 5 | 2.7 V | 1.0 | 3.9 | 7.7 | 1.0 | 10.0 | ns |
| | | | 3.0 V to 3.6 V | 1.0 | 3.5 | 7.7 | 1.0 | 10.0 | ns |
| t _{PHZ} | HIGH to | OE to An; see Fig. 5 | 2.7 V | 1.0 | 2.8 | 5.8 | 1.0 | 7.5 | ns |
| | OFF-state propagation delay | | 3.0 V to 3.6 V | 1.0 | 2.8 | 5.8 | 1.0 | 7.5 | ns |
| | propagation dolay | OE to Bn; see Fig. 5 | 2.7 V | 1.0 | 3.3 | 7.8 | 1.0 | 10.0 | ns |
| | | | 3.0 V to 3.6 V | 1.0 | 2.9 | 7.8 | 1.0 | 10.0 | ns |
| t _{sk(o)} | output skew time | | [2] | - | - | 1.0 | - | 1.5 | ns |
| C _{PD} | power dissipation capacitance | 5 V bus: Bn to An; $V_I = GND$ to $V_{CC(A)}$; $V_{CC(A)} = 5.0 \text{ V}$ | [3] | | | | | | |
| | | outputs enabled | - | - | 17 | - | - | - | pF |
| | | outputs disabled | - | - | 5 | - | - | - | pF |
| | | 3 V bus: An to Bn; $V_I = \text{GND to V}_{CC(B)};$ $V_{CC(B)} = 3.3 \text{ V}$ | [3] | | | | | | |
| | | outputs enabled | - | - | 17 | - | - | - | pF |
| | | outputs disabled | - | - | 5 | - | - | - | pF |

Typical values are measured at T_{amb} = 25 °C, $V_{CC(A)}$ = 5.0 V, and $V_{CC(B)}$ = 2.7 V and 3.3 V respectively. Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design. C_{PD} is used to determine the dynamic power dissipation (P_D in μ W). $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where: f_i = input frequency in MHz; f_o = output frequency in MHz;

 C_L = output load capacitance in pF; V_{CC} = supply voltage in Volts;

N = number of inputs switching; $\Sigma(C_L \times V_{CC})^2 \times f_0$ = sum of the outputs

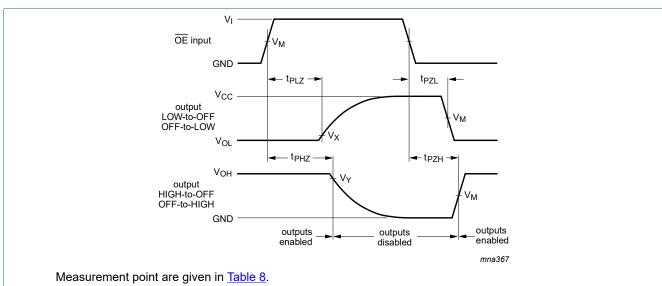
10.1. Waveforms and test circuit



Measurement point are given in Table 8.

V_{OL} and V_{OH} are typical output voltage drops that occur with the output load.

Fig. 4. Input (An, Bn) to output (Bn, An) propagation delays



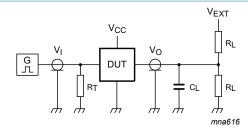
 V_{OL} and V_{OH} are typical output voltage drops that occur with the output load.

Fig. 5. 3-state enable and disable times

Table 8. Measurement points

| Supply voltage | | Input | | Output | | | |
|--------------------|--------------------------|----------------------|--------------------|----------------------|-------------------------|-------------------------|--|
| V _{CC(A)} | CC(A) V _{CC(B)} | | V _I [1] | V _M [2] | V _X | V _Y | |
| ≤ 2.7 V | ≤ 2.7 V | 0.5 V _{CCI} | V _{CCI} | 0.5 V _{CCO} | - | - | |
| - | 2.7 V to 3.6 V | 1.5 V | 2.7 V | 1.5 V | - | - | |
| ≥ 4.5 V | - | 0.5 V _{CCI} | 3.0 V | 0.5 V _{CCO} | - | - | |
| - | ≥ 2.7 V | - | V _{CCI} | - | V _{OL} + 0.3 V | V _{OH} - 0.3 V | |

- [1] V_{CCI} is the supply voltage associated with the data input port.
- V_{CCO} is the supply voltage associated with the data output port.



Test data is given in <u>Table 9</u>. Definitions for test circuit:

R_L = Load resistance.

 $\ensuremath{\text{C}_{\text{L}}}$ = Load capacitance including jig and probe capacitance.

 R_{T} = Termination resistance should be equal to output impedance Z_{o} of the pulse generator.

Fig. 6. Test circuit for measuring switching times

Table 9. Test data

| Supply voltage | | Input | Load | | V _{EXT} | | | |
|--------------------|---|------------------|-------------------------------------|-------------------------------------|---|-----|----------------------|--|
| V _{CC(A)} | V _{CC(B)} V _I [1] C _L R _L | | t _{PLH} , t _{PHL} | t _{PZH} , t _{PHZ} | t _{PZL} , t _{PLZ} [2] | | | |
| < 2.7 V | < 2.7 V | V _{CCI} | 50 pF | 500 Ω | open | GND | 2 × V _{CCO} | |
| - | 2.7 V to 3.6 V | 2.7 V | 50 pF | 500 Ω | open | GND | 2 × V _{CCO} | |
| 4.5 V to 5.5 V | - | 3.0 V | 50 pF | 500 Ω | open | GND | 2 × V _{CCO} | |

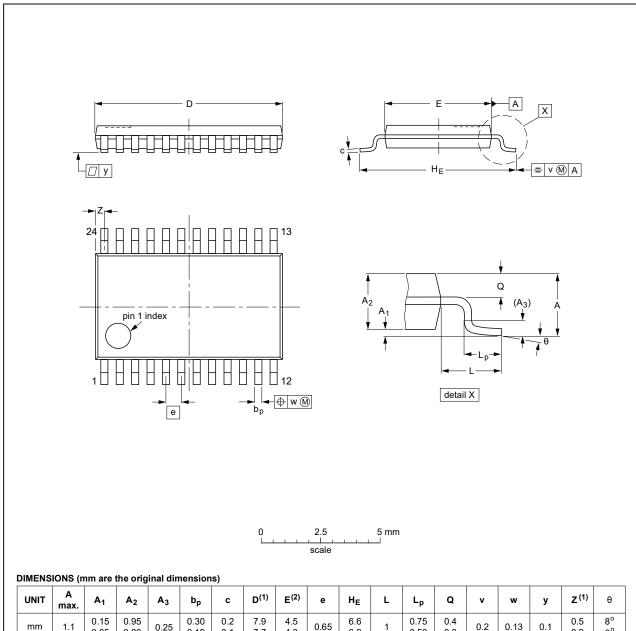
^[1] V_{CCI} is the supply voltage associated with the data input port.

^[2] V_{CCO} is the supply voltage associated with the output port.

11. Package outline

TSSOP24: plastic thin shrink small outline package; 24 leads; body width 4.4 mm

SOT355-1



| UNIT | A max. | A ₁ | A ₂ | A ₃ | bp | С | D ⁽¹⁾ | E ⁽²⁾ | е | HE | L | Lp | Q | v | w | у | Z ⁽¹⁾ | θ |
|------|-----------|----------------|----------------|----------------|--------------|------------|------------------|------------------|------|------------|---|--------------|------------|-----|------|-----|------------------|----------|
| mm | 1.1 | 0.15 0.05 | 0.95 0.80 | 0.25 | 0.30 0.19 | 0.2 0.1 | 7.9 7.7 | 4.5 4.3 | 0.65 | 6.6 6.2 | 1 | 0.75 0.50 | 0.4 0.3 | 0.2 | 0.13 | 0.1 | 0.5 0.2 | 8° 0° |

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | |
|----------|-----|--------|----------|------------|---------------------------------|
| VERSION | IEC | JEDEC | JEITA | PROJECTION | ISSUE DATE |
| SOT355-1 | | MO-153 | | | 99-12-27 03-02-19 |

Fig. 7. Package outline SOT355-1 (TSSOP24)

DHVQFN24: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body 3.5 x 5.5 x 0.85 mm

SOT815-1

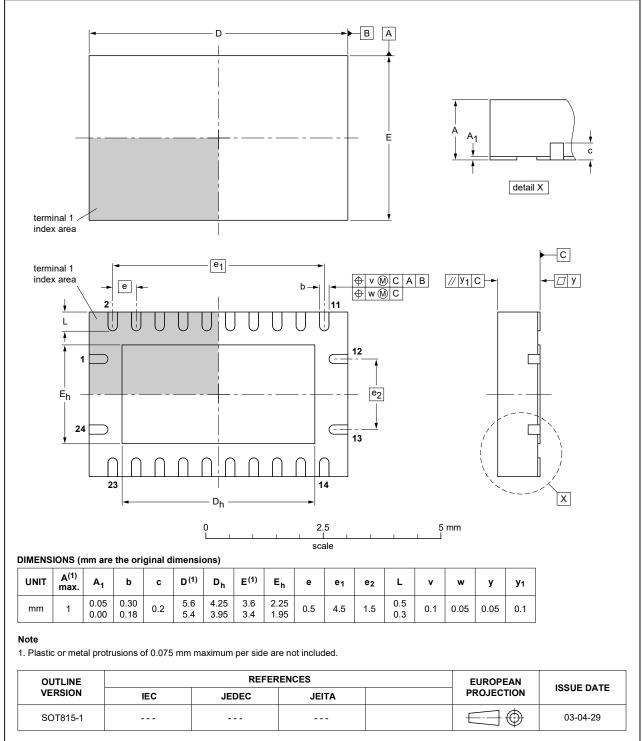


Fig. 8. Package outline SOT815-1 (DHVQFN24)

12. Abbreviations

Table 10. Abbreviations

| Acronym | Description |
|---------|---|
| CMOS | Complementary Metal-Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| НВМ | Human Body Model |
| TTL | Transistor-Transistor Logic |

13. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes | | |
|---------------------|---|--------------------|---------------|---------------------|--|--|
| 74LVC4245A_Q100 v.4 | 20230901 | Product data sheet | - | 74LVC4245A_Q100 v.3 | | |
| Modifications: | <u>Section 2</u>: ESD specification updated according to the latest JEDEC standard. Type number 74LVC4245AD (SO24/SOT137-1) removed. | | | | | |
| 74LVC4245A_Q100 v.3 | 20210412 | Product data sheet | - | 74LVC4245A_Q100 v.2 | | |
| Modifications: | <u>Section 9</u> : ΔI _{CC} conditions have changed. | | | | | |
| 74LVC4245A_Q100 v.2 | 20200922 | Product data sheet | - | 74LVC4245A_Q100 v.1 | | |
| Modifications: | The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Section 1 and Section 2 updated. Table 4: Derating values for P_{tot} total power dissipation updated. Measurement points related to Fig. 4 and Fig. 5 are given in Table 8. | | | | | |
| 74LVC4245A_Q100 v.1 | 20141020 | Product data sheet | - | - | | |

14. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|-----------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Nexperia sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between Nexperia and its customer, unless Nexperia and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the Nexperia product is deemed to offer functions and qualities beyond those described in the Product data sheet.

Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, Nexperia does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. Nexperia takes no responsibility for the content in this document if provided by an information source outside of Nexperia.

In no event shall Nexperia be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, Nexperia's aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the Terms and conditions of commercial sale of Nexperia.

Right to make changes — Nexperia reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use in automotive applications — This Nexperia product has been qualified for use in automotive applications. Unless otherwise agreed in writing, the product is not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or

Octal dual supply translating transceiver; 3-state

equipment, nor in applications where failure or malfunction of an Nexperia product can reasonably be expected to result in personal injury, death or severe property or environmental damage. Nexperia and its suppliers accept no liability for inclusion and/or use of Nexperia products in such equipment or applications and therefore such inclusion and/or use is at the customer's own rick.

Quick reference data — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. Nexperia makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using Nexperia products, and Nexperia accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the Nexperia product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

Nexperia does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using Nexperia products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). Nexperia does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — Nexperia products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nexperia.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. Nexperia hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of Nexperia products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

Contents

| 1. General description | 1 |
|-------------------------------------|----|
| 2. Features and benefits | 1 |
| 3. Ordering information | 1 |
| 4. Functional diagram | 2 |
| 5. Pinning information | 3 |
| 5.1. Pinning | 3 |
| 5.2. Pin description | 3 |
| 6. Functional description | 3 |
| 7. Limiting values | 4 |
| 8. Recommended operating conditions | 4 |
| 9. Static characteristics | 6 |
| 10. Dynamic characteristics | 8 |
| 10.1. Waveforms and test circuit | 9 |
| 11. Package outline | 11 |
| 12. Abbreviations | 13 |
| 13. Revision history | 13 |
| 14. Legal information | |
| | |

For more information, please visit: http://www.nexperia.com For sales office addresses, please send an email to: salesaddresses@nexperia.com Date of release: 1 September 2023

[©] Nexperia B.V. 2023. All rights reserved